

MGV High Current Molded SMT Power Inductors MGV0512 Series

FEATURES AND APPLICATIONS

Laird MGV series high current power inductors improve performance, reliability and power efficiency. A lower profile benefits consumer electronics and telecom design. Products feature extremely low DCR with greater efficiency and enable a large current in a small size. Inductors are of magnetic shielding and molded construction and perform in operating temperatures ranging from -55 C to 125 C including self-heating rise in temperature.

FEATURES

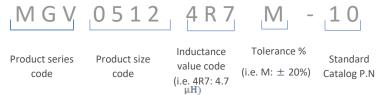
- · Magnetic shielded structure
- · Low DCR and high efficiency
- Low profile and miniaturization
- High reliability

APPLICATIONS

- DC-DC Converter and Power Suppliers
- LCD TV'S and Gaming Console
- Tablet, Notebooks, Servers and Printers
- Networking and Data storage
- GPS, Set-top-box and Base stations
- Smart meters and Medical instruments



PART NUMBER EXPLANATION



Note: Automotive grade parts are also available, a specific P.N will be assigned upon request. Please contact laird local sales for details.

ELECTRICAL SPECIFICATIONS

- Tolerance: M: ±20% or N: ±30%
- Inductance tested at 100KHz, 1.0V
- Heat Rated Current (Irms) is defined based on temperature rise approximate 40°C without core loss (ambient temperature 25±5°C)
- Saturation Current (Isat) is the DC current at which the inductance drops off approximately 30% from its value without current. (ambient temperature 25±5°C)
- Operating temperature range: -40°C~+125°C (including self-heating temperature rise)
- Storage temperature range (packaging conditions): -10°C~+40°C and RH 60%(MAX.)

Note: Heat Rated Current (Irms) is tested on a typical PCB and apply a constant current in still air.

The temperature rise is dependent on the application system condition including PCB PAD pattern, trace width and thickness and adjacent components etc. It's suggested to verify the temperature rise of the component under the real operation application conditions.



Molded SMT Power Inductors

					www.laird.com	MGV0512 S	Series	Rev: A
SPECII	FICATIO	N						
1.MECHA	NICAL & DI	IMENSI	ONS				(UI)	NIT: mm)
						А	5.50	0±0.30
A						В	5.20	0±0.20
						С	1.00	0±0.20
A	00		+-	+ -	+ +	D	2.20	0±0.50
				h		E	1.10	0±0.30
					E	L	6.2	20 ref
	в -	-	c	-	D =	G	2.2	20 ref
			·	·	' '	Н	2.8	30 ref
					L	RE	MARK	
					← G ←			
					//// н			
					l			
2.PART N	UMBER NO	MENCL	ATOR:					
MGV	0512	100	М -	1X	D: Inductance Tolerance. (±30%)	
Α	В	С	D	Ε	E: "X"=0:Standard catalog	part number		
A: Pro	oduct Series.				"X"=1-9:Controlled custo			
B: Se	ries number, p	oart size			performance than s		rt. And	"5-9" is
C: Inc	luctance code				for automotive grade	e.		
3.EQUIVA	LENT CIRC	CUIT:						
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SPECIFICATION								
PART NUMBER	INDUCTANCE (uH)	Irms(A) Typ.	Isat(A) Typ.	DCR(mΩ) Typ	DCR(mΩ) Max	REMARK		
MGV0512R10N-10	0.10±30%	14.0	14.5	4.3	5.2			
MGV0512R22N-10	0.22±30%	10.7	14.0	5.5	6.7			
MGV0512R47M-10	0.47±20%	7.0	11.0	13.6	15.8			
MGV0512R68M-10	0.68±20%	6.0	9.0	21.5	24.5			
MGV05121R0M-10	1.00±20%	5.0	6.0	26.0	30.0			
MGV05121R2M-10	1.20±20%	4.5	5.5	33.0	40.0			
MGV05121R5M-10	1.50±20%	4.0	5.0	38.0	44.0			
MGV05122R2M-10	2.20±20%	3.5	4.0	65.0	75.0			
MGV05123R3M-10	3.30±20%	3.0	3.8	75.0	86.0			
MGV05124R7M-10	4.70±20%	2.5	3.2	100.0	115.0			
MGV05126R8M-10	6.80±20%	2.0	3.0	193.0	222.0			
MGV0512100M-10	10.0±20%	1.5	1.8	335.0	385.0			
MGV0512150M-10	15.0±20%	1.3	1.6	410.0	470.0			

GENERAL SPECIFICATION:

- Inductance tested at 100KHz, 0.25V
- Heat Rated Current (Irms) is defined based on temperature rise approximate 40°C without core loss (ambient temperature 25±5°C)
- Saturation Current (Isat) is the DC current at which the inductance drops off approximately 30% from

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its value without current. (ambient temperature 25±5°C)	
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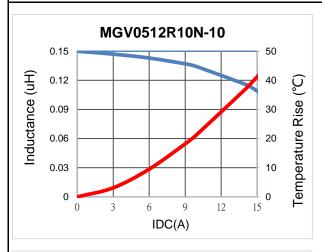


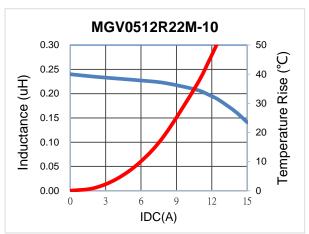
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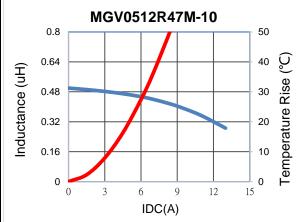
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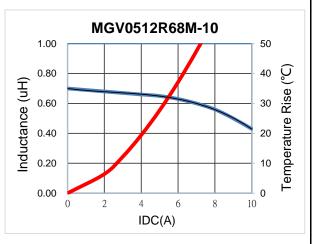
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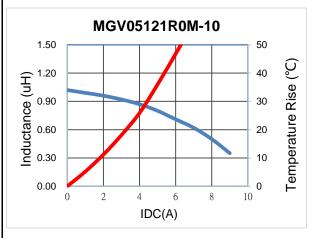
Characteristics Curve

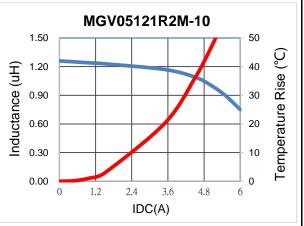












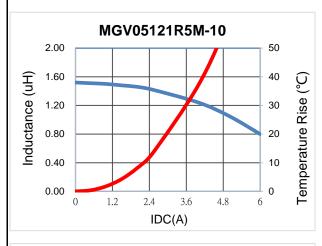


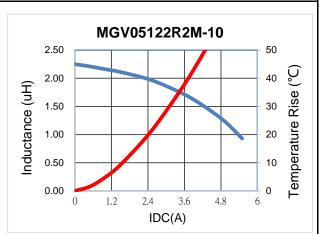
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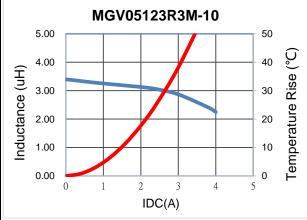
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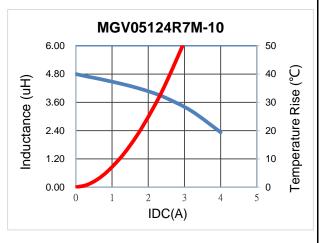
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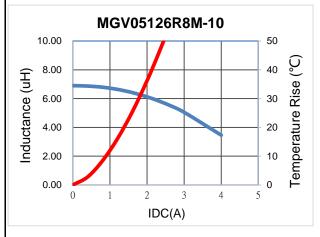
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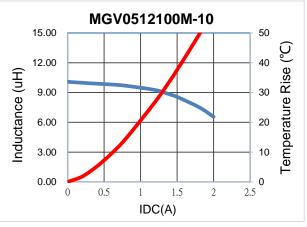












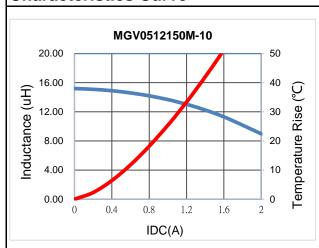


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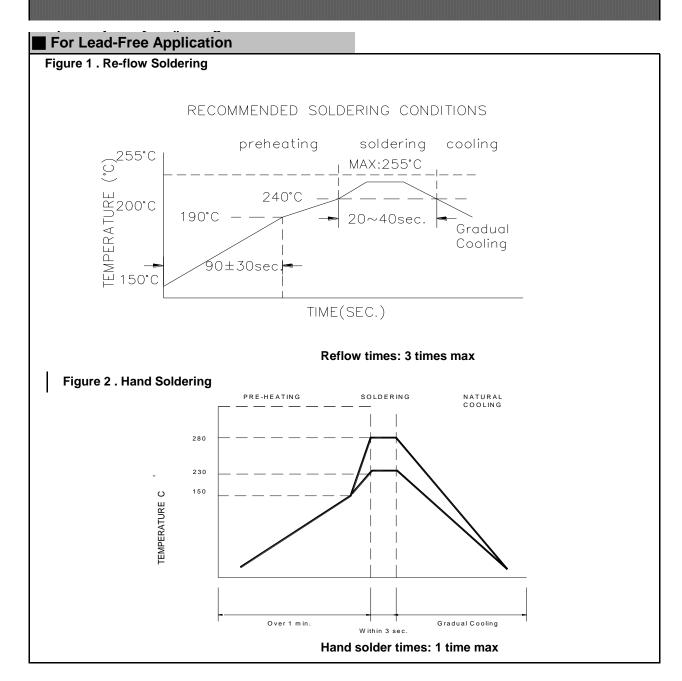




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Recommended Soldering Conditions





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	oting Conditions / Bin Type Bo	www.laird.com MGV0512 Series Rev: A					
Reliability and Te	stina Conditions / Pin Tvpe Po	wer inductors					
SMD series(Consumer)							
Item	Reference	Additional Requirements					
Operating temperature range	-55°C ~ +125°C (Including self-temperature rise)						
Storage temperature and humidity range	-10℃ to +40℃ , 60% RH Max						
High Temperature Exposure (Storage)	MIL-STD-202 Method 108	85±2℃, 168+24hours					
Temperature Cycling	JESD22 Method JA-104	-40°C →+85, transforming interval:20s, 100cycles					
Operational Life	MIL-PRF-2	85±℃, 168+24hours Apply maximum rated voltage and current according part drawing					
External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking and workmanship. Electrical Test not required.					
Physical Dimension	JESD22 Method JB-100	Verify physical dimensions to the applicable device detail specification. Note: User(s) and Suppliers spec. Electrical Test not required					
Vibration	MIL-STD-202 Method 204	10~55Hz,1.5mm, 2 hours in each 3mutually perpendicular directions (total of 6 hours)					
Resistance to Soldering Heat	MIL-STD-202 Method 210	1. Max. 260±5°C,10±1s, 2 times 2.Solder Composition: Sn/3Ag/0.5Cu					
Solderability	J-STD-002	245±5°C, 5±1sec, Solder: Sn/3.0Ag/0.5Cu					
Electrical Characterization	Print Spec	Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max Operating temperatures					
Board Flex	AEC-Q200-005	2mm,30±1s					
Terminal Strength(SMD)	AEC-Q200-006	10N, 5S, X,Y direct					

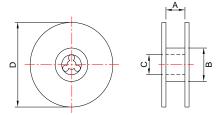


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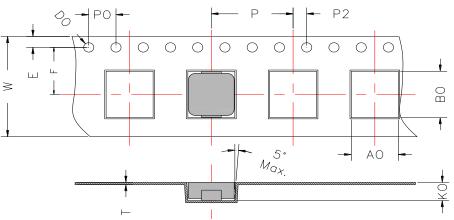
PACKAGING

Reel Dimension



Туре	A(mm)	B(mm)	C(mm)	D(mm)
13'x12	12.4+2/-0	100 ± 2	13+0.5/-0.2	330

Tape Dimension

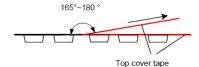


W	E	F	Р	A0	В0	P2	P0	K0	t	D0
12.0±0.3	1.75±0.1	5.50±0.1	8.00±0.1	5.50±0.1	6.20±0.1	2.0±0.1	4.0±0.1	1.5±0.1	0.35±0.05	1.5Ref.

Packaging Quantity

P/N	Chip/Reel	Inner Box	Outer Box
#REF!	4000pcs	8000pcs	16000pcs
Size	Э	-	-

Peeling Off Force



The force peeling off cove tape is 10 to 100 grams						
in the arrow direction under the following conditions						
Room Temp	Room Temp Room Room atrn Teaming					
(℃)	Humidity	(hPa)	Speed			
5~35	45~85	860~1060	300			

Storage Conditions

- Temperature and humidity conditions: -10-+40°C and 60% RH.
- Recommended products should be used within 12 month from the time of manufacturing.
- The packaging material should be kept where no chloring or sulfur exists in the air.
- 4. Allowable stacking condition of Packaging box: max height 1.5m or 5 boxes stacking

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Laird Performance Materials:

MGV05121R2M-10 MGV0512R47M-10 MGV05123R3M-10 MGV05124R7M-10 MGV05126R8M-10

MGV05121R5M-10 MGV05121R0M-10 MGV0512150M-10 MGV0512R10N-10 MGV05122R2M-10 MGV0512R68M
10 MGV0512100M-10